ETR0301-007

Positive Voltage Regulators

■GENERAL DESCRIPTION

The XC6201 series are highly precise, low power consumption, positive voltage regulators manufactured using CMOS and laser trimming technologies.

The series provides large currents with a significantly small dropout voltage.

The XC6201 consists of a current limiter circuit, a driver transistor, a precision reference voltage and an error amplifier. Output voltage is selectable in 0.1V steps between $1.3V \sim 6.0V$.

SOT-25, SOT-89 and USP-6B packages are available.

■APPLICATIONS

- Smart phones / Mobile phones
- Portable game consoles
- Digital still cameras / Camcorders
- Digital audio equipment
- Reference voltage sources
- Multi-function power supplies

■FEATURES

Maximum Output Current: 250mA (TYP.)Dropout Voltage: 0.16V @ 100mA

: 0.40V @ 200mA

Maximum Operating Voltage : 10V

Output Voltage Range : 1.3V ~ 6.0V (0.1V increments)

Fixed Voltage Accuracy : $\pm 1\%$ (V_{OUT(T)} ≥ 2.0 V)

±2%

Low Power Consumption: $2.0 \,\mu$ A (TYP.)Operating Ambient Temperature: -40° C $\sim 85^{\circ}$ CPackages: SOT-25,

SOT-89

USP-6B

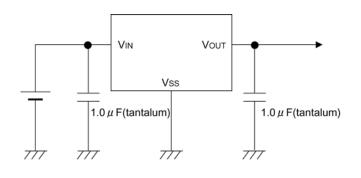
Environmentally Friendly : EU RoHS Compliant, Pb Free

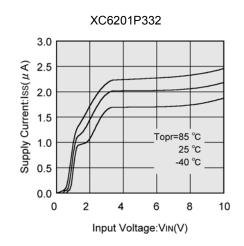
Tantalum or Ceramic Capacitor compatible

■TYPICAL APPLICATION CIRCUIT

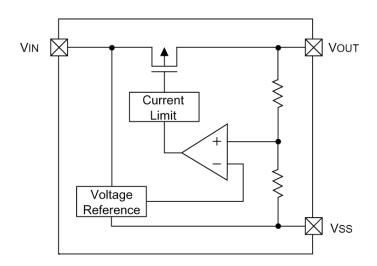
■TYPICAL PERFORMANCE CHARACTERISTICS

Supply Current vs. Input Voltage



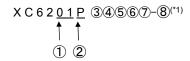


■BLOCK DIAGRAM



■PRODUCT CLASSIFICATION

Ordering Information

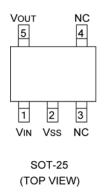


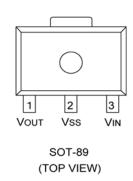
DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
1	Product Number	01	-
2	Type of Regulator	Р	3-pin regulator
34	Output Voltage	13~60	e.g. 30:3.0V 50:5.0V
(5)	Output Voltage Accuracy	1	±1%
3)		2	±2%
		MR	SOT-25 (3,000pcs/Reel)
		MR-G	SOT-25 (3,000pcs/Reel)
67-8	Packages	PR	SOT-89 (1,000pcs/Reel)
000	(Order Unit)	PR-G	SOT-89 (1,000pcs/Reel)
		DR	USP-6B (3,000pcs/Reel)
		DR-G	USP-6B (3,000pcs/Reel)

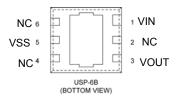
^(*1) The "-G" suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.

^{*} $\pm 1\%$ accuracy can be set at $V_{OUT(T)} \ge 2.0V$.

■PIN CONFIGURATION







*The dissipation pad for the USP-6B package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the VSS (No.5) pin.

■PIN ASSIGNMENT

	PIN NUMBER		PIN NAME	FUNCTION	
SOT-25	SOT-89	USP-6B	PIN NAME	FUNCTION	
5	1	3	Vout	Output	
2	2	5	Vss	Ground	
1	3	1	Vin	Power Input	
3, 4	_	2,4,6	NC	No Connection	

■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAM	IETER	SYMBOL	RATINGS	UNITS
Input V	oltage o	Vin	12.0	V
Output (Current	Іоит	500	mA
Output \	Output Voltage		VSS-0.3~VIN+0.3	V
Power	SOT-25		250	
Dissipation	SOT-89	Pd	500	mW
Dissipation	USP-6B		120	
Operating Temperature		Topr	-40~+85	°C
Storage Temperature		Tstg	-55 ~ +125	°C

■ELECTRICAL CHARACTERISTICS

XC6201P132 V_{OUT(T)}=1.3V ^(*1) Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	V _{OUT(E)} (*2)	V _{IN} =2.3V I _{OUT} =10mA	1.274	1.300	1.326	V	2
Maximum Output Current	I _{OUTmax}	V _{IN} =2.3V V _{OUT(E)} ≧1.17V	60	-	-	mA	2
Load Regulation	ΔVоυт	V _{IN} =2.3V 1mA≦I _{OUT} ≦30mA	-	10	30	mV	2
Dropout Voltage (*3)	Vdif1	I _{OUT} =30mA	1	200	600	m\/	2
Dropout Voltage ()	Vdif2	I _{OUT} =60mA	-	500	810	mV	2
Supply Current	Iss	V _{IN} =2.3V	ı	2.0	5.0	μΑ	1
Line Regulation	$\frac{\Delta V_{\text{OUT}}}{\Delta V_{\text{IN}} \cdot \Delta V_{\text{OUT}}}$	I _{OUT} =10mA 2.3V≦V _{IN} ≦10.0V	-	0.2	0.3	%/V	2
Input Voltage	V _{IN}		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{\text{OUT}}}{\Delta \text{Topr} \cdot \Delta V_{\text{OUT}}}$	I _{OUT} =40mA -40°C≦Topr≦85°C	1	±100	-	ppm/°C	2

XC6201P182 V_{OUT(T)}=1.8V ^(*1) Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	V _{OUT(E)} (*2)	V _{IN} =2.8V IOUT=40mA	1.764	1.800	1.836	V	2
Maximum Output Current	I _{OUTmax}	V _{IN} =2.8V V _{OUT(E)} ≧1.62V	80	-	-	mA	2
Load Regulation	ΔVоυт	V _{IN} =2.8V 1mA≦I _{OUT} ≦40mA	-	10	30	mV	2
Dropout Voltage (*3)	Vdif1	I _{OUT} =40mA	-	200	370	m\/	2
Dropout voltage (37	Vdif2	I _{OUT} =80mA	-	450	710	mV	2
Supply Current	Iss	V _{IN} =2.8V	-	2.0	5.0	μΑ	1
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	I _{OUT} =40mA 2.8V≦V _{IN} ≦10.0V	-	0.2	0.3	%/V	2
Input Voltage	VIN		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{\text{OUT}}}{\Delta \text{Topr} \cdot \Delta V_{\text{OUT}}}$	I _{OUT} =40mA -40°C≦Topr≦85°C	-	±100	-	ppm/°C	2

XC6201P272 Vout(T)=2.7V (*1) Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	V _{OUT(E)} (*2)	V _{IN} =3.7V I _{OUT} =40mA	2.646	2.700	2.754	V	2
Maximum Output Current	I _{OUTmax}	V _{IN} =3.7V V _{OUT(E)} ≧2.43V	100	-	ı	mA	2
Load Regulation	ΔVоυт	V _{IN} =3.7V 1mA≦I _{OUT} ≦60mA	-	15	40	mV	2
Dropout Voltage (*3)	Vdif1	I _{OUT} =60mA	-	200	370	m\/	2
Diopout voltage (37	Vdif2	I _{OUT} =120mA	-	450	710	mV	2
Supply Current	Iss	V _{IN} =3.7V	-	2.0	5.0	μΑ	1
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	I _{OUT} =40mA 3.7V≦V _{IN} ≦10.0V	-	0.2	0.3	%/V	2
Input Voltage	Vin		1.8	-	10	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta V_{\text{OUT}}}{\Delta \text{Topr} \cdot \Delta V_{\text{OUT}}}$	I _{OUT} =40mA -40°C≦Topr≦85°C	-	±100	-	ppm/°C	2

■ ELECTRICAL CHARACTERISTICS (Continued)

XC6201P332 V_{OUT(T)}=3.3V ^(*1) Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	Vout(E) (*2)	V _{IN} =4.3V I _{OUT} =40mA	3.234	3.300	3.366	V	2
Maximum Output Current	IOUTmax	V _{IN} =4.3V V _{OUT(E)} ≧2.97V	150	-	-	mA	2
Load Regulation	ΔV_{OUT}	V _{IN} =4.3V 1mA≦I _{OUT} ≦80mA	-	20	50	mV	2
Dropout Voltage (*3)	Vdif1	I _{оит} =80mA	-	200	360	mV	2
Diopout voltage ()	Vdif2	I _{OUT} =160mA	-	450	700	IIIV	
Supply Current	I _{SS}	V _{IN} =4.3V	-	2.0	5.0	μΑ	1
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot \Delta V_{OUT}}$	I _{OUT} =40mA 4.3V≦V _{IN} ≦10.0V	-	0.2	0.3	%/V	2
Input Voltage	Vin		1.8	-	10	V	-
Output Voltage Temperature Characteristics	ΔV_{OUT} $\Delta Topr \cdot \Delta V_{OUT}$	I _{OUT} =40mA -40°C≦Topr≦85°C	-	±100		ppm/°C	2

XC6201P502 Vout(T)=5.0V (*1) Ta=25°C

AG02011 302 V001(1) 3.0 V						1a-25 C	
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	V _{OUT(E)} (*2)	V _{IN} =6.0V I _{OUT} =40mA	4.900	5.000	5.100	V	2
Maximum Output Current	I _{OUTmax}	VI _N =6.0V V _{OUT(E)} ≧4.57V	200	-	-	mA	2
Load Regulation	ΔVоυт	V _{IN} =6.0V 1mA≦I _{OUT} ≦100mA	-	30	70	mV	2
Dropout Voltage (*3)	Vdif1	I _{OUT} =100mA	-	160	340	m\/	2
Dropout Voltage (9)	Vdif2	I _{OUT} =200mA	-	400	600	mV	(2)
Supply Current	Iss	V _{IN} =6.0V	-	2.0	6.0	μΑ	1
Line Regulation	$\frac{\Delta V_{\text{OUT}}}{\Delta V_{\text{IN}} \cdot \Delta V_{\text{OUT}}}$	I _{OUT} =40mA 6.0V≦V _{IN} ≦10.0V	1	0.2	0.3	%/V	2
Input Voltage	Vin		1.8	-	10	V	-
Output Voltage Temperature Characteristics	ΔV_{OUT} $\Delta \text{Topr} \cdot \Delta V_{\text{OUT}}$	I _{OUT} =40mA -40°C≦Topr≦85°C	-	±100	-	ppm/°C	2

NOTE:

VIN1 :An Input Voltage when V_{OUT1} appears as the input voltage is gradually decreased. V_{OUT1} : A voltage equal to 98% of the output voltage when a stabilized ($V_{OUT(T)}$ + 1.0V) is input.

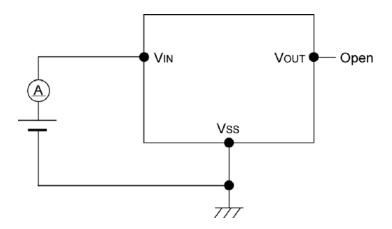
^{*1:} $V_{OUT(T)}$ = Nominal output voltage.

^{*2:} V_{OUT(E)} = Effective output voltage (i.e. the output voltage when "V_{OUT(T)}+1.0V" is provided while maintaining a certain I_{OUT} value).

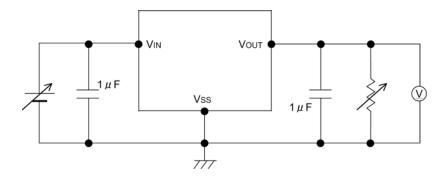
^{*3:} $Vdif = (V_{IN1} - V_{OUT1})$

■TEST CIRCUITS

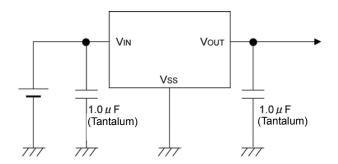
Circuit ① : Supply Current



Circuit ②: Output Voltage, Oscillation, Line Regulation, Dropout Voltage, Load Regulation

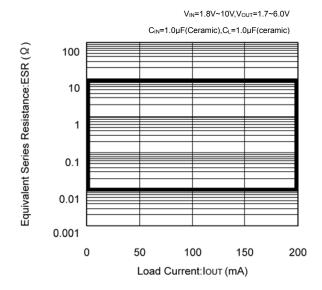


■ OPERATIONAL EXPLANATION



With the XC6201 series regulator, in order to ensure the stabilized output voltage, we suggest that an output capacitor (C_L) of 1 μ F or more be connected between the output pin (V_{OUT}) and the V_{SS} pin. For using low ESR capacitor (e.g. ceramic capacitors), please make sure that the output voltage is more than 1.7V. When the output voltage is from 1.3V to 1.6V, the output capacitor should be a tantalum capacitor with a capacitance of 2.2 μ F. We also suggest an input capacitor (C_{IN}) should be connected between the V_{IN} and the V_{SS} in order to stabilize input power source.

OUTPUT VOLTAGE	CIN	CL (TANTALUM)	CL (LOW ESR)
1.3V~1.6V	≧1.0 <i>μ</i> F	≧2.2 <i>μ</i> F	_
1.7V~6.0V	≧1.0 <i>μ</i> F	≧1.0 <i>μ</i> F	≧1.0 <i>μ</i> F



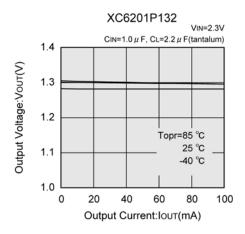
XC6201 Series

NOTE ON USE

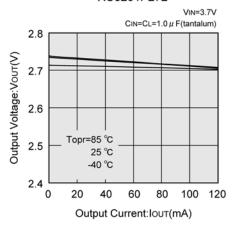
- 1. Please use this IC within the stated absolute maximum ratings. The IC is liable to malfunction should the ratings be exceeded. When a voltage higher than the V_{IN} flows to the V_{OUT} like when using two power supplies, please connect a Schottky barrier diode between the V_{OUT} and the V_{IN} and do not exceed the V_{OUT} rating.
- 2. An oscillation may occur by the impedance between a power supply and the input of the IC. Where the impedance is $10\,\Omega$ or more, please use an input capacitor (C_{IN}) of at least $1\,\mu$ F. In case of high output current, operation can be stabilized by increasing the input capacitor value. Also an oscillation may occur if the input capacitor value is smaller than the input impedance when the output capacitance (C_{L}) is large. In such cases, operations can be stabilized by either increasing the input capacitor value or reducing the output capacitor value.
- 3. Please ensure that output current (I_{OUT}) is less than Pd / (V_{IN} V_{OUT}) and do not exceed the rated power dissipation value (Pd) of the package.

■TYPICAL PERFORMANCE CHARACTERISTICS

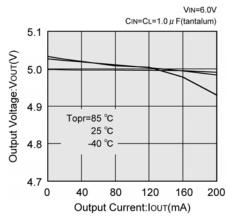
(1) Output Voltage vs. Output Current

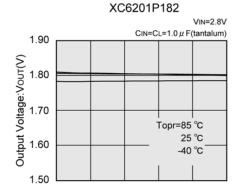


XC6201P272



XC6201P502





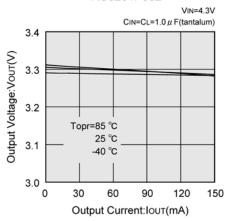
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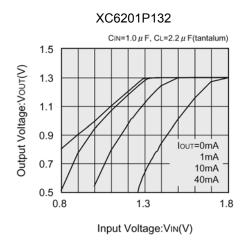
Output Current:IouT(mA)

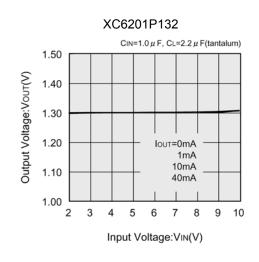
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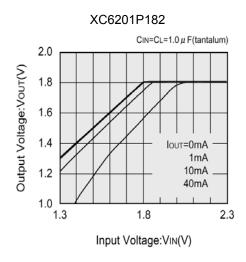
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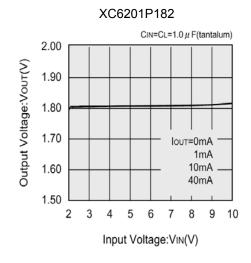


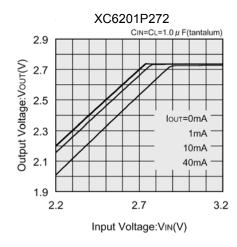
(2) Output Voltage vs. Input Voltage

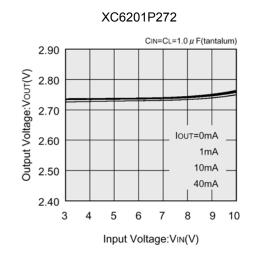




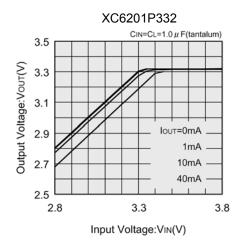


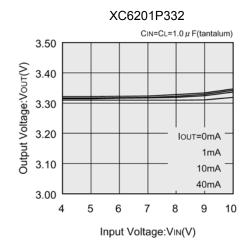


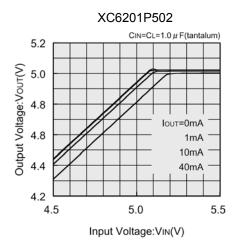


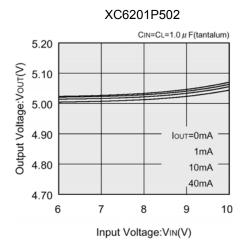


(2) Output Voltage vs. Input Voltage (Continued)

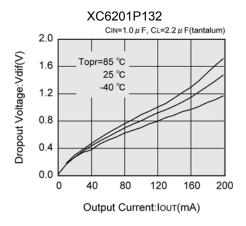




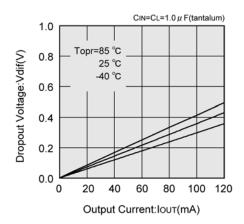




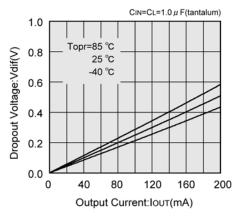
(3) Dropout Voltage vs. Output Current

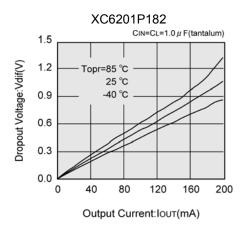


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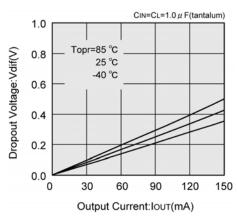


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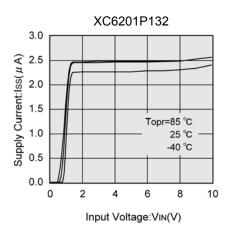


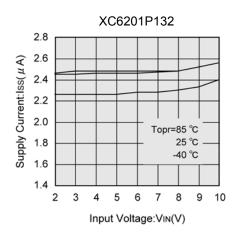


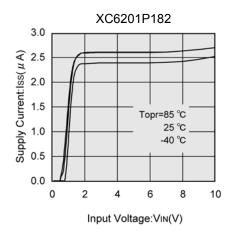
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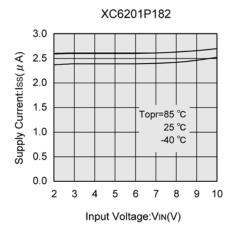


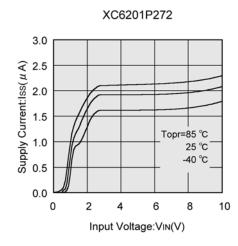
(4) Supply Current vs. Input Voltage

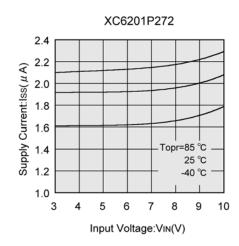




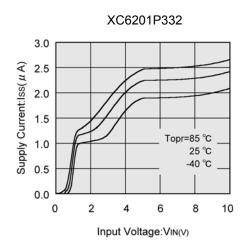


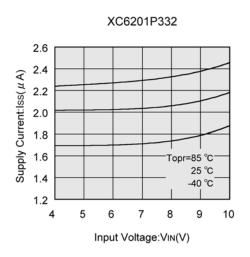


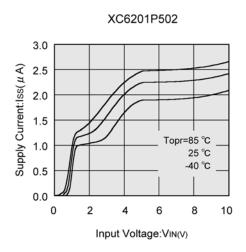


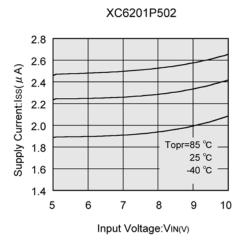


(4) Supply Current vs. Input Voltage (Continued)

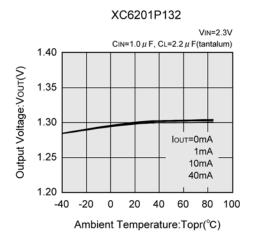




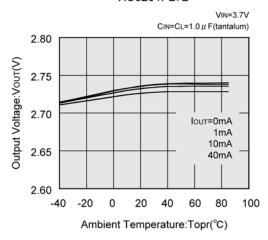




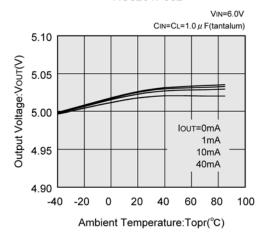
(5) Output Voltage vs. Ambient Temperature

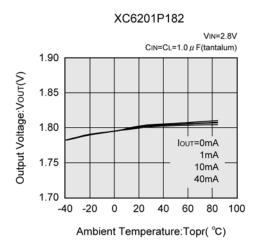


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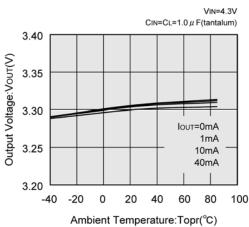


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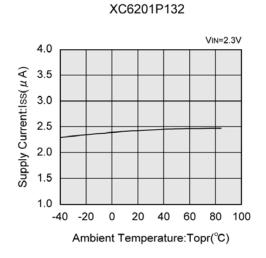


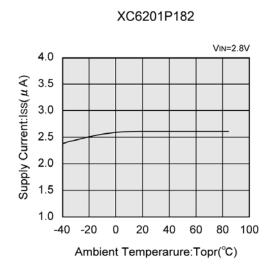


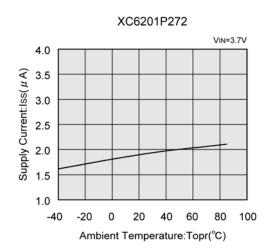
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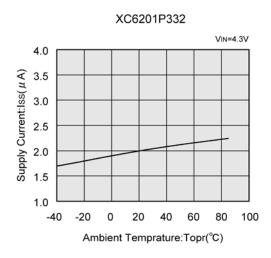


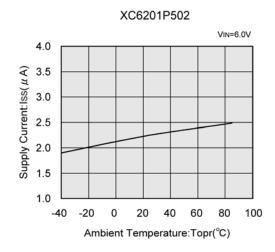
(6) Supply Current vs. Ambient Temperature



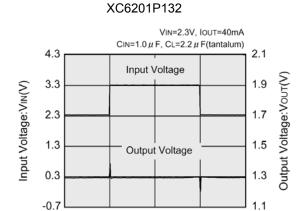




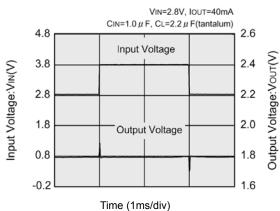




(7) Input Transient Response

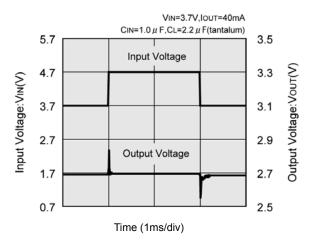


XC6201P182

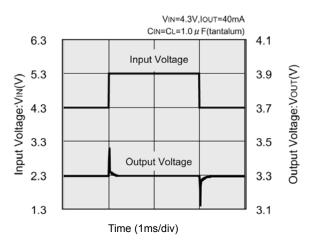


XC6201P272

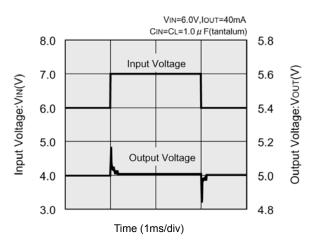
Time (1ms/div)



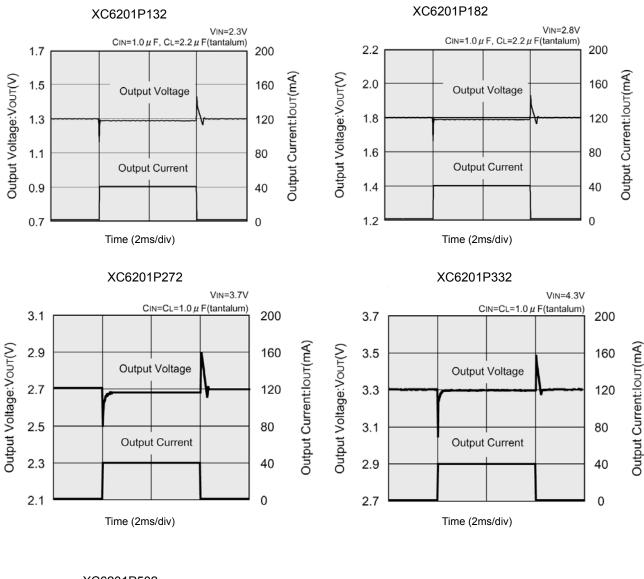
XC6201P332

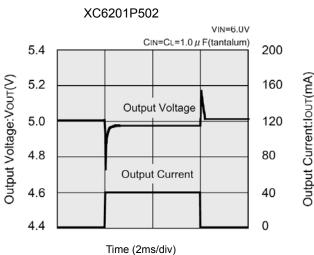


XC6201P502



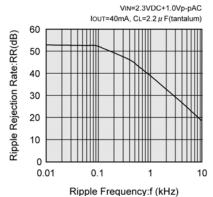
(8) Load Transient Response



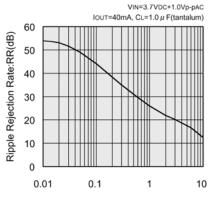


(9) Ripple Rejection Rate



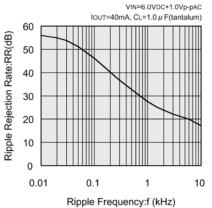


XC6201P272

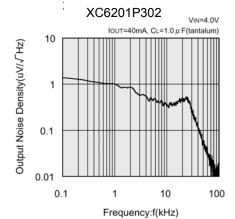


Ripple Frequency:f (kHz)

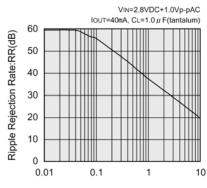
XC6201P502



(10) Output Noise Density

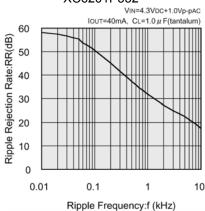


XC6201P182



Ripple Frequency:f (kHz)

XC6201P332

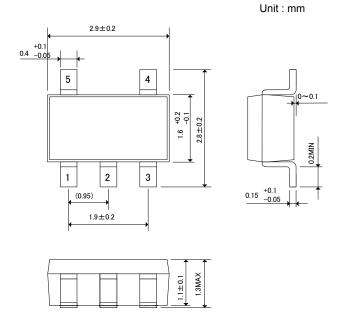


TOIREX 19/27

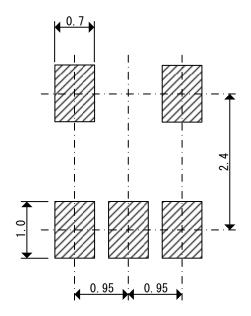
XC6201 Series

■PACKAGING INFORMATION

●SOT-25



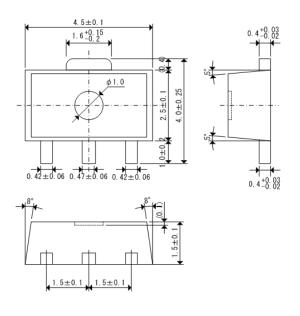
●SOT-25 Reference Pattern Layout

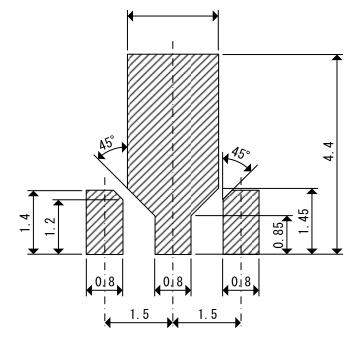


●SOT-89

Unit: mm

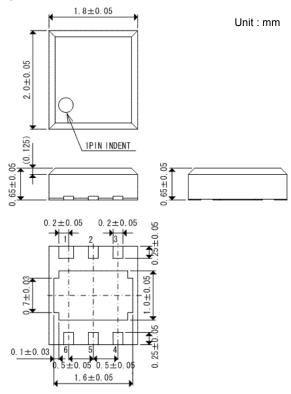
●SOT-89 Reference Pattern Layout





■ PACKAGING INFORMATION (Continued)

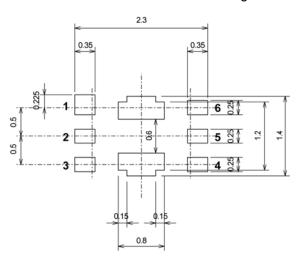
●USP-6B



●USP-6B Reference Pattern Layout

2.4 0.45 0

●USP-6B Reference Metal Mask Design



● SOT-25 Power Dissipation

Power dissipation data for the SOT-25 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as the reference data taken in the following condition.

1. Measurement Condition

Condition: Mount on a board Ambient: Natural convection Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm2 in one side)

Copper (Cu) traces occupy 50% of the board

area In top and back faces

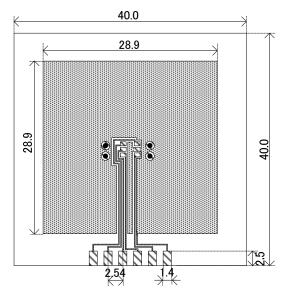
Package heat-sink is tied to the copper traces

(Board of SOT-26 is used.)

Material: Glass Epoxy (FR-4)

Thickness: 1.6mm

Through-hole: 4 x 0.8 Diameter

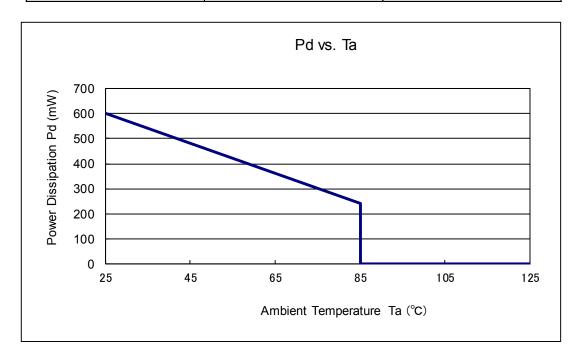


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

Board Mount (Tj max = 125°C)

Ambient Temperature (°C)	Power Dissipation Pd(mW)	Thermal Resistance (°C/W)
25	600	166.67
85	240	100.07



SOT-89 Power Dissipation

Power dissipation data for the SOT-89 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as the reference data taken in the following condition.

1. Measurement Condition

Condition: Mount on a board Ambient: Natural convection Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm2 in one side)

Copper (Cu) traces occupy 50% of the board

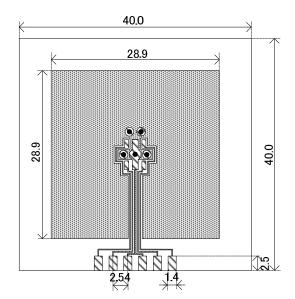
area In top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6mm

Through-hole: 5 x 0.8 Diameter

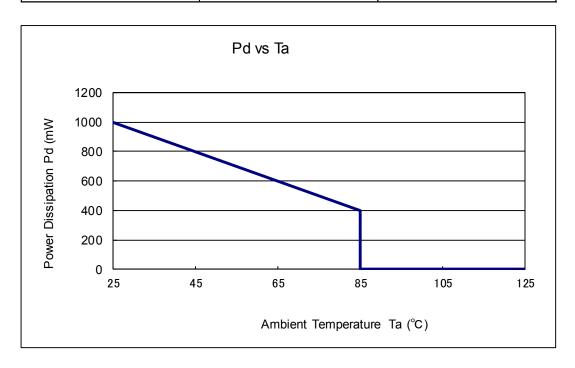


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

Board Mount (Tj max = 125°C)

	Ambient Temperature (°C)	Power Dissipation Pd(mW)	Thermal Resistance (°C/W)	
ĺ	25	1000	100.00	
	85	400	100.00	



● USP-6B Power Dissipation

Power dissipation data for the USP-6B is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as the reference data taken in the following condition.

1. Measurement Condition

Condition: Mount on a board Ambient: Natural convection Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm2 in one side)

Copper (Cu) traces occupy 50% of the board

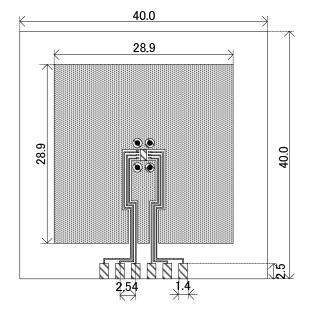
area In top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6mm

Through-hole: 4 x 0.8 Diameter

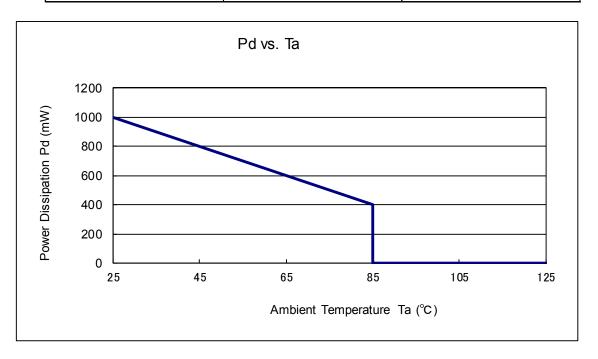


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

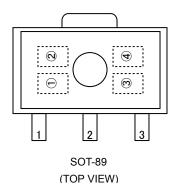
Board Mount (Tj max = 125°C)

Ambient Temperature (°C)	Power Dissipation Pd(mW)	Thermal Resistance (°C/W)		
25	1000	, ,		
85	400	100.00		



■ MARKING RULE

●SOT-89, SOT-25



① represents the product series

MARK	PRODUCT SERIES
1	XC6201xxxxxx

2 represents type of regulator

MA	RK	PRODUCT SERIES	
Voltage= 0.1 ~ 3.0V	Voltage= 3.1 ~ 6.0V		
5	6	XC6201Pxxxxx	
8	9	XC6201TxxxPx	

5 4 1 2 3 4 SOT-25 (TOP VIEW)

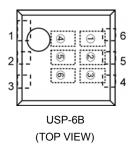
③ represents output voltage

MARK	OUTPUT VOLTAGE (V)		MARK	OUTP	UT VOLTA	GE (V)	
0	ı	3.1	ı	F	1.6	4.6	-
1	I	3.2	I	Η	1.7	4.7	1
2	-	3.3	-	K	1.8	4.8	_
3	ı	3.4	ı	L	1.9	4.9	-
4	I	3.5	I	М	2.0	5.0	1
5	I	3.6	I	Ν	2.1	5.1	ı
6	-	3.7	-	Р	2.2	5.2	_
7	ı	3.8	ı	R	2.3	5.3	-
8	I	3.9	I	S	2.4	5.4	ı
9	-	4.0	-	Т	2.5	5.5	_
Α	ı	4.1	ı	U	2.6	5.6	-
В	ı	4.2	ı	V	2.7	5.7	-
С	1.3	4.3	_	Х	2.8	5.8	_
D	1.4	4.4	ı	Y	2.9	5.9	_
Е	1.5	4.5	-	Z	3.0	6.0	_

④ represents assembly lot number 0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)

■MARKING RULE (Continued)

●USP-6B



①② represents product series

3 represents type of regulator

MARK	TYPE	PRODUCT SERIES
Р	3pin Regulator	XC6201PxxxDx
Т	VIN=7V(Rated)	XC6201TxxxDx

45 represents output voltage

MARK		VOLTAGE (V)	PRODUCT SERIES	
4	5	VOLIAGE (V)	FRODUCT SERIES	
3	3	3.3	XC6201x33xDx	
5	0	5.0	XC6201x50xDx	

⑥ represents assembly lot number 0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)

Note: No character inversion used.

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